

Date Created : 2006/07/19
Date Issued On : 2006/08/21
PCN# : Q3063001

INFORMATION ONLY NOTIFICATION

This is to inform you that a minor change is being made to the following product(s). This notification is for your information only.

If you have any questions concerning this change, please contact:

Technical Contact:

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Phone: 82-32-680-1216

PCN Originator:

Name: SONG, HEEYUNG
E-mail: HEEYUNG.SONG@fairchildsemi.com
Phone: 82-32-680-1216

Implementation of change:

Expected 1st Device Shipment Date: 2006/08/27

Earliest Year/Work Week of Changed Product: 0636

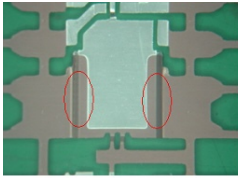
Change Type Description: Lead Frame Dimensions (Internal and External)

Description of Change (From): There is no slot on leadframe.

Description of Change (To): There are 6 slots on leadframe.

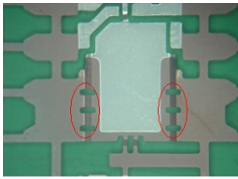
Reason for Change : To improve adhesion between Mold compound and LeadFrame.

Change From



Current

Change To



New

Product Id Description : All devices packaged with 8DIPH

Affected FSIDs :

FSD210BH	FSD210DH	FSD210HD
FSD210HD_NL	FSD211H	FSD211H_NL